



Click [here](#) for the 3D model.

| Dimensions | |
|------------|-----------------|
| Chip Size | 1250(5350) |
| AEC-Q200 | Yes |
| L | 13.2mm +/-0.4mm |
| W | 12.5mm +/-0.2mm |
| T | 5mm MAX |
| G | 4.7mm +/-0.3mm |

| Packaging Specifications | |
|--------------------------|------------|
| Typical Component Weight | 4.2 g |
| Packaging | T&R, 330mm |
| Packaging Quantity | 250 |

| General Information | |
|---------------------|------------------------------|
| Series | MPXV |
| Style | SMD Molded |
| Core | Metal Composite |
| Description | Surface Mount Inductor |
| Features | Power Inductors |
| RoHS | Yes |
| Qualifications | AEC-Q200 |
| AEC-Q200 | Yes |
| Miscellaneous | 40 (K) Temperature Rise Max. |

| Specifications | |
|-------------------------|--|
| Inductance | 10 uH |
| Inductance Tolerance | 20% |
| Temperature Range | -55/+155°C |
| Shielded | Yes |
| Current | 10.1 A (Irms, 40C Rise By Self Heating), 9 A (Isat, 20% Drop In Inductance), 13.5 A (Isat, 30% Drop In Inductance) |
| DC Resistance | 20.6 mOhms |
| Self-Resonant Frequency | 8.5 MHz |

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